

MOS FIELD EFFECT TRANSISTOR 2SJ581

SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SJ581 is P-Channel DMOS Field Effect Transistor that features a low on-resistance and excellent switching characteristics, designed for high current switching applications such as DC to DC converter and load switch.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ581	MP-10

FEATURES

- Low on-state resistance :
 - $R_{DS(on)1} = 70 \text{ m}\Omega \text{ TYP. (} V_{GS} = -10 \text{ V, } I_D = -6 \text{ A)}$
 - $R_{DS(on)2} = 120 \text{ m}\Omega \text{ TYP. (} V_{GS} = -4 \text{ V, } I_D = -6 \text{ A)}$
- Low input capacitance :
 - $C_{iss} = 1210 \text{ pF TYP. (} V_{DS} = -10 \text{ V, } f = 1\text{MHz)}$
- Narrow gate cut-off voltage width :
 - $V_{GS(off)} = -1.0 \text{ to } -2.0 \text{ V}$
- Built-in gate protection diode.
- Suitable to automatically assembling.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Drain to Source Voltage	V_{DSS}	-60	V
Gate to Source Voltage	$V_{GSS(AC)}$	± 20	V
Gate to Source Voltage	$V_{GSS(DC)}$	-20, 0	V
Drain Current (DC)	$I_{D(DC)}$	± 12	A
Drain Current (pulse) ^{Note}	$I_{D(pulse)}$	± 48	A
Total Power Dissipation ($T_A = 25^\circ\text{C}$)	P_T	1.8	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

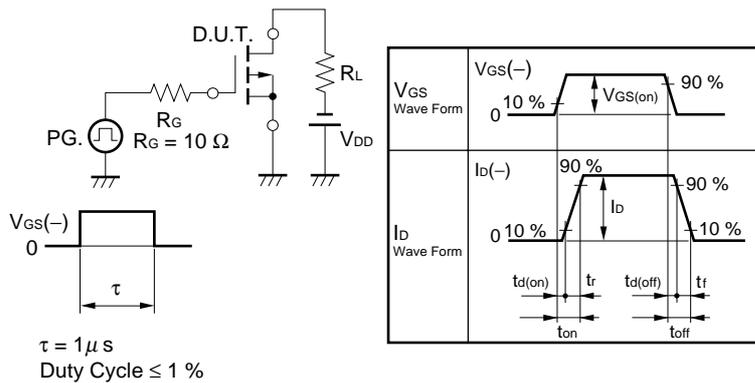
Note $PW \leq 10 \mu\text{s}$, Duty Cycle $\leq 1\%$

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

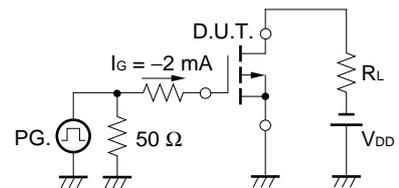
ELECTRICAL CHARACTERISTICS(T_A = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V			-10	μA
Gate Leakage Current	I _{GSS}	V _{GS} = ±10 V, V _{DS} = 0 V			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1.0 mA	-1.0		-2.0	V
Forward Transfer Admittance	y _{fs}	V _{DS} = -10 V, I _D = -6 A	5.0			S
Drain to Source On-state Resistance	R _{DS(on)1}	V _{GS} = -10 V, I _D = -6 A		70	100	mΩ
	R _{DS(on)2}	V _{GS} = -4 V, I _D = -6 A		120	185	mΩ
Input Capacitance	C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		1210		pF
Output Capacitance	C _{oss}			520		pF
Reverse Transfer Capacitance	C _{rss}			180		pF
Turn-on Delay Time	t _{d(on)}	I _D = -6 A, V _{GS(on)} = -10 V, V _{DD} = -30 V, R _G = 10 Ω		15		ns
Rise Time	t _r			130		ns
Turn-off Delay Time	t _{d(off)}			95		ns
Fall Time	t _f			80		ns
Total Gate Charge	Q _G	I _D = -12 A, V _{DD} = -48 V, V _{GS(on)} = -10 V		42		nC
Gate to Source Charge	Q _{GS}			8.0		nC
Gate to Drain Charge	Q _{GD}			10		nC
Diode Forward Voltage	V _{F(S-D)}	I _F = -12 A, V _{GS} = 0 V		1.0		V
Reverse Recovery Time	t _{rr}	I _F = -12 A, V _{GS} = 0 V, di/dt = 100 A/μs		120		ns
Reverse Recovery Charge	Q _{rr}			230		nC

TEST CIRCUIT 1 SWITCHING TIME

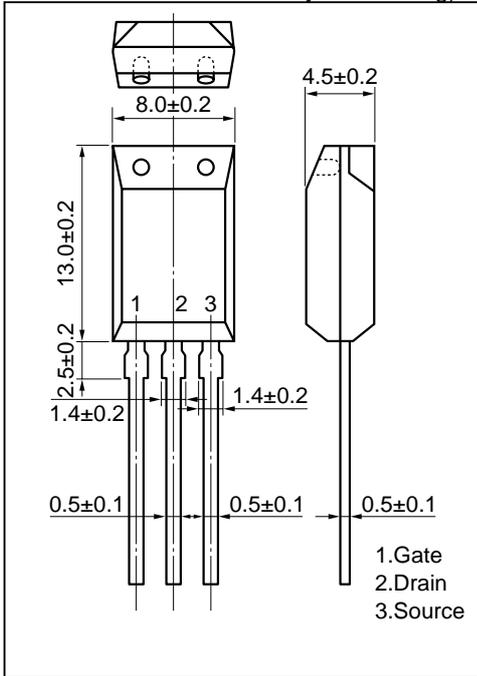


TEST CIRCUIT 2 GATE CHARGE

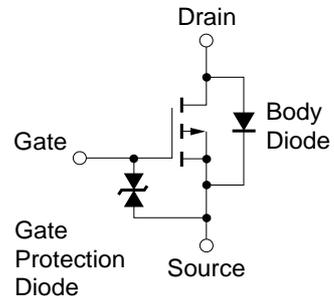


PACKAGE DRAWING (Unit : mm)

MP-10 (Isolated TO-220 class Package
for Automatically Assembling)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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